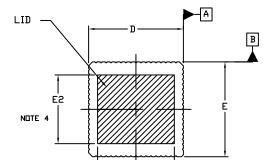


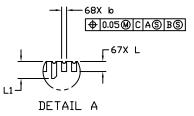
PLCC68, 24.13x24.13 CASE 115AQ ISSUE A

SEATING PLANE **DATE 01 DEC 2011**

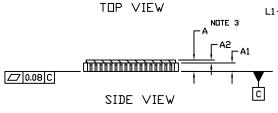




- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- DIMENSION A INCLUDES THE PACKAGE BODY AND LID BUT DOES NOT INCLUDE HEATSINKS OR OTHER ATTACHED FEATURES.
- THE LID DEFINED BY DIMENSIONS D2 AND E2 MUST BE LOCATED WITHIN DIMENSIONS D AND E.

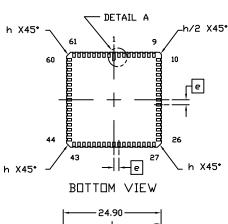


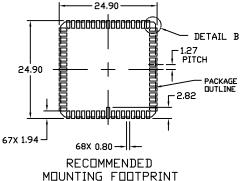
| | MILLIMETERS | | |
|-----|-----------------------------------|-------|--|
| DIM | MIN. | MAX. | |
| Α | 2.98 | 4.10 | |
| A1 | 3.05 REF | | |
| A2 | 0.49 REF | | |
| b | 0.50 | 0.77 | |
| D | 23.88 | 24.51 | |
| D2 | 19.50 REF | | |
| Ε | 23.88 | 24.51 | |
| E2 | 17.50 REF 1.27 BSC 1.02 REF | | |
| e | | | |
| h | | | |
| L | 1.07 | 1.47 | |
| 1.1 | 1.91 | 2.41 | |



NOTE 4

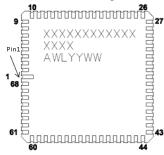






GENERIC MARKING DIAGRAM

Bottom of Package



XXXXX = Specific Device Code A = Assembly Location

WL = Wafer Lot YY = Year WW = Work Week NNNN = Serial Number

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|------------------|----------------------|--|-------------|
| DESCRIPTION: | LCC68, 24.13 X 24.13 | | PAGE 1 OF 1 |

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